

EVM User's Guide: DAC80502-01EVM

DAC80502-01 Evaluation Module



Description

The [DAC80502-01EVM](#) is an easy-to-use platform to evaluate the functionality and performance of the [DAC80502](#) and [DAC80501](#) devices. The DAC80502-01EVM has optional circuits and jumpers to configure the device for different applications. The DAC80502 and DAC80501 are both installed on the EVM.

DAC80501 is a single-channel, buffered, low-voltage-output digital-to-analog converter (DAC) in 16-bit resolution. DAC80502 is a dual-channel, buffered, low-voltage-output DAC in 16-bit resolution. The devices provide unipolar output voltage up to 5 V.

Get Started

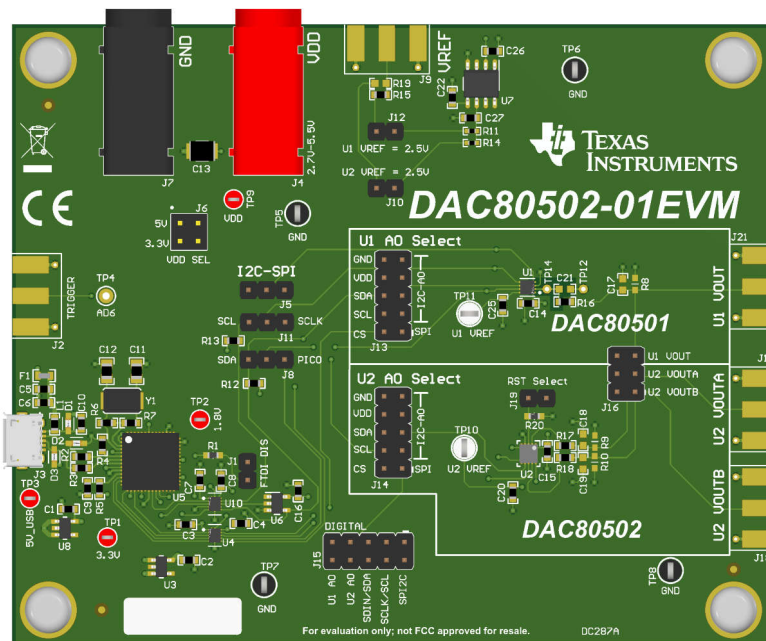
1. Order the [EVM](#).
2. Configure EVM jumpers.
3. Install the DAC805xxEVM GUI from ti.com.
4. Connect USB and external power supplies.
5. Launch the DAC805xxEVM GUI.

Features

- Configurable circuit to evaluate the DACx0501 and DACx0502 family of devices
- Onboard VDD (5-V or 3.3-V) support via USB and on-board voltage regulators
- FT4232 easily writes to the DAC using the DAC805xxEVM GUI
- Option for external reference voltage or on-board 2.5-V reference voltage
- Trigger output is available for synchronous measurement
- External SPI and I²C connections available

Applications

- [Oscilloscopes and digitizers](#)
- [Parametric measurement unit \(PMU\)](#)
- [Data acquisition \(DAQ\)](#)
- [Flat panel display \(FPD\) shorting bar pattern generator](#)
- [Small cell base station](#)
- [Analog output module](#)
- [Process analytics \(pH, gas, concentration, force and humidity\)](#)
- [Programmable dc power supply](#)



1 Evaluation Module Overview

1.1 Introduction

The DACx050x digital-to-analog converter (DAC) is a highly accurate, low-power device with voltage output. The DACx050x is specified monotonic by design and offer linearity of less than 1 LSB. These devices include a 2.5-V, 5-ppm/°C internal reference, giving full-scale output voltage ranges of 1.25 V, 2.5 V, or 5 V.

The DACx050x incorporates a power-on-reset (POR) circuit that makes sure the DAC output powers up at zero-scale or mid-scale, and remains at that scale until a valid code is written to the device. These devices consume a low current of 1 mA, and include a power-down feature that reduces current consumption to typically 15 μ A at 5 V.

The digital interface of the DACx050x can be configured to SPI or I²C mode using the SPI2C pin. In SPI mode, the DACx050x uses a versatile 3-wire serial interface that operates at clock rates of up to 50 MHz. In I²C mode, the DACx050x operates in standard mode (100Kbps), fast mode (400Kbps), and fast mode plus (1.0Mbps).

This user's guide describes the characteristics, operation, and recommended use cases of the DAC80502-01EVM. This document provides examples and instructions on how to use the DAC80502-01EVM board and included software. Throughout this document, the terms evaluation board, evaluation module, and EVM are synonymous with the DAC80502-01EVM. This document also includes schematics, the reference printed circuit board (PCB) layouts, and a complete bill of materials (BOM).

1.2 Kit Contents

[Table 1-1](#) details the contents of the EVM kit. Contact the TI Product Information Center at (972) 644-5580 if any component is missing. Download the latest versions of the related software on the TI website, www.ti.com.

Table 1-1. DAC80502-01EVM Kit Contents

Item	Quantity
DAC80502-01EVM board	1
USB micro-B plug to USB-A plug cable	1

1.3 Specification

The EVM is intended to provide basic functional evaluation of the device. The layout is not intended to be a model for the target circuit, nor laid out for electromagnetic compatibility (EMC) testing. The EVM consists of a printed-circuit board (PCB), which has the DAC80501 and DAC80502 installed.

1.4 Device Information

[Table 1-2](#) lists the devices supported by the DAC80502-01EVM. DACx050x is used as a generic name for these devices. This document focuses on the DAC80501 and DAC80502 that come pre-installed on the EVM.

Table 1-2. DAC80502-01EVM Supported Devices

DACx050x	DAC Resolution	Number of DACs
DAC60501	12-bit	1
DAC70501	14-bit	1
DAC80501	16-bit	1
DAC60502	12-bit	2
DAC70502	14-bit	2
DAC80502	16-bit	2

2 Hardware

2.1 Hardware Setup

This section describes the overall system setup for the EVM. A computer runs software that communicates with the FTDI controller onboard using I²C or SPI protocols.

2.1.1 Hardware Theory of Operation

The DAC80502-01EVM is connected to the computer through the on-board FTDI digital controller using the USB cable that is supplied with the EVM. The evaluation board features connectors and test points for all communication lines, DAC outputs, and supplies. [Figure 2-1](#) shows a block diagram of the DAC80502-01EVM.

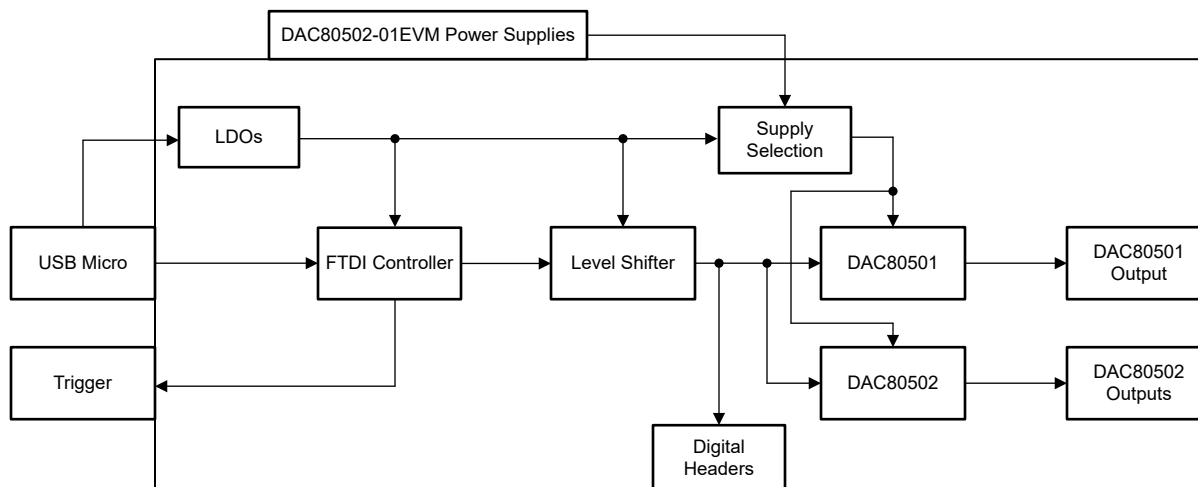


Figure 2-1. Theory of Operation Block Diagram

The USB connection provides the 5-V supply to the EVM. Voltage regulators generate 3.3 V and 1.8 V from the USB 5-V supply. These 3.3-V and 1.8-V supplies are used to power the FTDI controller.

The DAC80501 and DAC80502 VDD supplies can use the on-board 5-V or 3.3-V supplies depending on the jumper J6 setting. By default, VDD is connected to the on-board 5-V supply. Alternatively, VDD can be supplied externally through banana jack J4. Remove the jumper connector on J6 before connecting external supplies to VDD.

The device reference voltage can be supplied by an onboard 2.5-V voltage regulator by shorting jumper J10 for DAC80502 and J12 for DAC80501, or from an external supply with SMA connector J9. Make sure that the internal reference is powered off before connecting any other voltage supply to the VREFIO pin.

Each of the DAC outputs have footprints available for capacitor and resistor loads that are unpopulated by default.

2.1.2 Jumper Definitions

The jumpers must be connected properly to operate the DAC80502-01EVM. [Table 2-1](#) provides the details of the configurable jumper settings of the DAC80502-01EVM. [Figure 2-2](#) shows the default jumper connections on the board.

Table 2-1. DAC80502-01EVM Jumper Definitions

Designator	Name	Positions
J1	FTDI DIS	SHORT 1-2 – FTDI communication is disabled. OPEN – FTDI communication is enabled (default).
J5	I2C-SPI	SHORT 1-2 – SPI2C connected to ground for SPI communication (default). SHORT 2-3 – SPI2C connected to VDD for I ² C Configuration. OPEN – SPI2C floating, invalid position.
J6	VDD SEL	SHORT 1-2 – VDD is connected to USB 5 V (default). SHORT 3-4 – VDD is connected to on-board 3.3 V. OPEN – VDD is externally powered.
J8	SDA - PICO	SHORT 1-2 – Connects the DAC80501 and the DAC80502 SDIN/SDA pins to the FTDI PICO pin for SPI mode (default). SHORT 2-3 – Connects the DAC80501 and the DAC80502 SDIN/SDA pins to the FTDI SDA pin for I ² C Mode. OPEN – Open if external communication is used.
J10	U2 VREF = 2.5V	SHORT 1-2 – Connects the DAC80502 VREFIO pin to the on-board 2.5-V reference. Make sure the internal reference is powered off before closing this jumper. OPEN – Open if internal reference or external reference via J9 is used (default). If an external reference is used, then turn off the internal reference.
J11	SCL - SCLK	SHORT 1-2 – Connects the DAC80501 and the DAC80502 SCLK/SCL pins to the FTDI SCLK pin for SPI mode (default). SHORT 2-3 – Connects the DAC80501 and the DAC80502 SCLK/SCL pins to the FTDI SCL pin for I ² C Mode.
J12	U1 VREF = 2.5V	SHORT 1-2 – Connects the DAC80501 VREFIO pin to the on-board 2.5-V reference. Make sure the internal reference is powered off before closing this jumper. OPEN – Open if internal reference or external reference via J9 is used (default). If an external reference is used, then turn off the internal reference.
J13	U1 A0 Select	SHORT 1-2 – DAC80501 SPI configuration (default). SHORT all else – DAC80501 I ² C configuration, see Table 2-7 for jumper configurations. OPEN – Open if external communication is used.
J14	U2 A0 Select	SHORT 1-2 – DAC80502 SPI configuration (default) SHORT all else – DAC80502 I ² C configuration, see Table 2-7 for jumper configurations. OPEN – Open if external communication is used.
J19	RST Select	SHORT 1-2 – DAC80502 RSTSEL pin is connected to VDD. OPEN – DAC80502 RSTSEL pin is connected to GND (default).

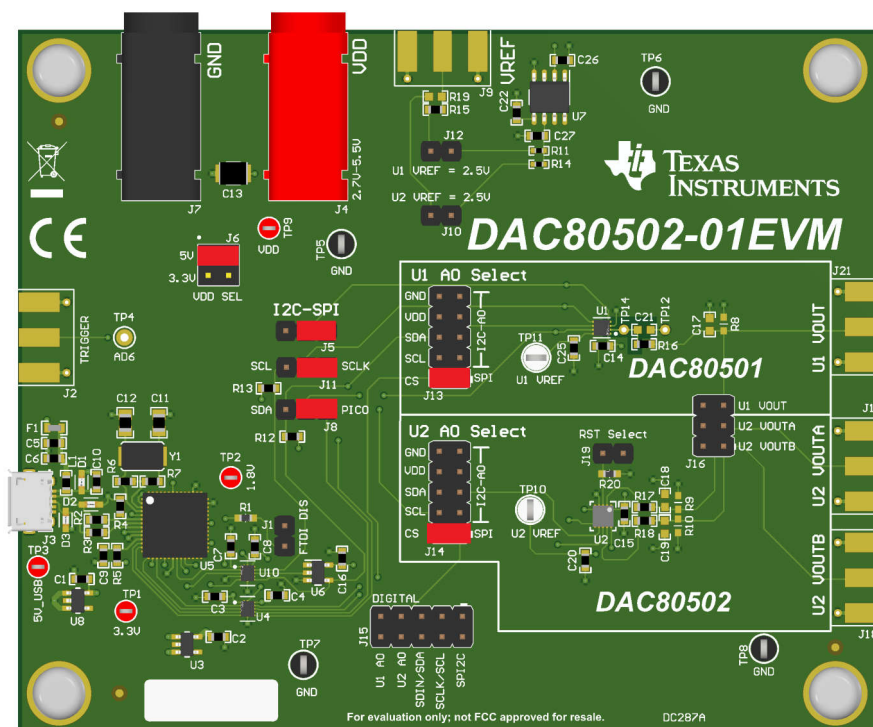


Figure 2-2. DAC80502-01EVM Default Jumper Settings

2.1.3 Connector Definitions

Table 2-2 shows the power connector definitions of the DAC80502-01EVM.

Table 2-2. Power Connector Definitions

Designator	Definition
J2	SMA connector for FTDI Trigger Input (unpopulated)
J3	USB connector
J4	DAC80501 and DAC80502 VDD supply (2.7 V to 5.5 V)
J7	DAC80501 and DAC80502 ground
J9	<p>SMA connector for DAC80501 and DAC80502 external reference voltage (unpopulated)</p> <p>The DAC references are connected to this SMA by resistors R15 (DAC80501) and R19 (DAC80502)</p> <p>To avoid shorting the two references together, R19 is unpopulated by default</p>

Table 2-3 shows output connector definitions for the DAC80502-01EVM.

Table 2-3. Output Connector Definitions

Designator	Definition
J17	SMA connector for DAC80502 VOUTA (unpopulated)
J18	SMA connector for DAC80502 VOUTB (unpopulated)
J21	SMA connector for DAC80501 VOUT (unpopulated)

Table 2-4 shows output header J16 definitions for the DAC80502-01EVM.

Table 2-4. Output Header J16 Definitions

Pin	Definition
1	DAC80501 VOUT
3	DAC80502 VOUTA
5	DAC80502 VOUTB
2, 4, 6	Ground

2.1.4 Test Points

The DAC80502-01EVM has a variety of test points available for measuring and debugging purposes. Table 2-5 explains the purpose of each test point.

Table 2-5. DAC80502-01EVM Test Points

Test Point	Net	Description
TP1	3p3V	On-board 3.3-V supply
TP2	1p8V	On-board 1.8-V supply
TP3	5V_USB	On-board USB 5-V supply
TP4	AD6	FTDI Trigger test point (unpopulated)
TP5, TP6, TP7, TP8	GND	Ground test points
TP9	VDD	VDD test point
TP10	VREF_2	DAC80502 reference test point
TP11	VREF_1	DAC80501 reference test point
TP12	GND	Dedicated ground test point for measuring VOUT noise
TP14	VOUT	Dedicated DAC80501 VOUT test point for measuring VOUT noise

2.2 Hardware Overview

This section details how to configure the EVM for voltage outputs using I²C and SPI. The following subsections provide detailed information on the EVM hardware and jumper positions for the two communication modes (see also [Section 2.1.2](#)).

2.2.1 Electrostatic Discharge Caution

CAUTION

Many of the components on the DAC80502-01EVM are susceptible to damage by electrostatic discharge (ESD). Customers are advised to observe proper ESD handling precautions when unpacking and handling the EVM, including the use of a grounded wrist strap at an approved ESD workstation.

2.2.2 Connecting the FTDI Digital Controller

To connect the FTDI digital controller on the EVM board to the computer, align and firmly connect the USB connector to the J3 connector. Verify the connection is snug; a loose connection can cause intermittent operation. A 100 mil header (J15) is available for external communication. [Table 2-6](#) lists the J15 pin definitions. To use external communication, close jumper J1 to disable the connection to the FTDI controller. When using I²C, TI recommends to close the J8 and J11 jumpers in the I²C positions, as the jumpers connect the pull-up resistors R12 and R13 to the communication lines.

Table 2-6. Digital Header J15 Pin Definitions

Pin	Definition
2	DAC80501 and DAC80502 SPI2C
4	DAC80501 and DAC80502 SCLK/SCL
6	DAC80501 and DAC80502 SDIN/SDA
8	DAC80502 SYNC/A0
10	DAC80501 SYNC/A0
1, 3, 5, 7, 9	Ground

2.2.3 SPI Configuration

[Figure 2-3](#) shows the DAC80502-01EVM configured for SPI communication.

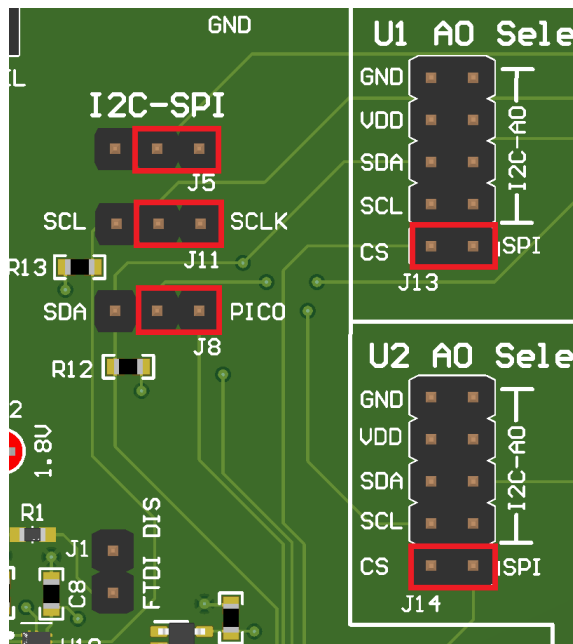


Figure 2-3. DAC80502-01EVM SPI Configuration

2.2.4 I²C Configuration

Figure 2-4 shows the DAC80502-01EVM configured for I²C communication.

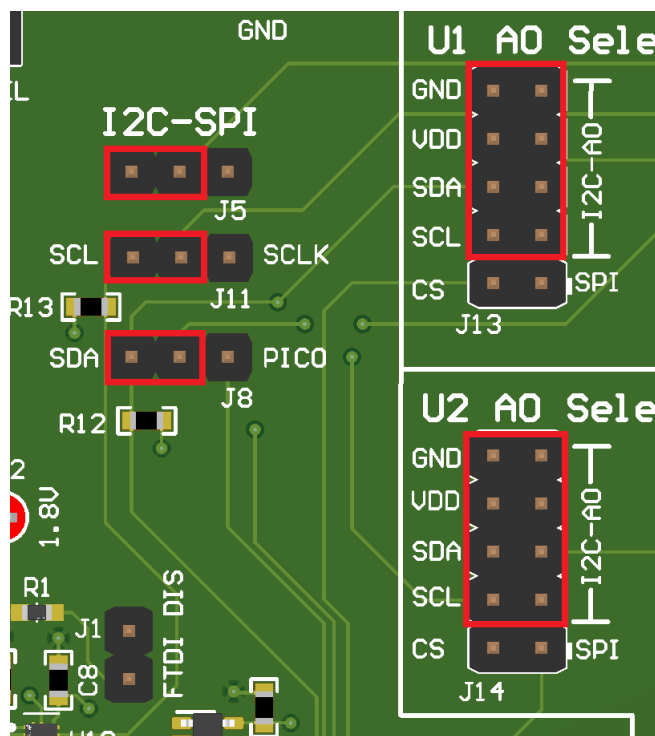


Figure 2-4. DAC80502-01EVM I²C Configuration

The jumper connections on J13 and J14 determine the device address of the DAC80501 and DAC80502, respectively. Table 2-7 shows the required configuration of the two A0 jumpers for specific device addresses.

Table 2-7. I²C Device Address Map

A0 Connection	[A6:A0]
GND	1001 000
VDD	1001 001
SDA	1001 010
SCL	1001 011

3 Software

3.1 Software Setup

This section provides the procedure for EVM software installation.

3.1.1 Software Installation

Note

Do not connect the EVM to the computer while the software is installing.

Download the latest version of the EVM graphical user interface (GUI) installer from the *Order and start development* subsection of the [DAC80502-01EVM tool folder](#) on TI.com. Run the GUI installer to install the DAC805xx GUI software on your computer. The software installation automatically copies the required LabVIEW™ software files and drivers to the computer.

When the DAC805xx GUI is launched, an installation dialog window opens and prompts the user to select an installation directory. If left unchanged, [Figure 3-1](#) shows that the software location defaults to *C:\Program Files (x86)\Texas Instruments\DAC805xxEVM*.

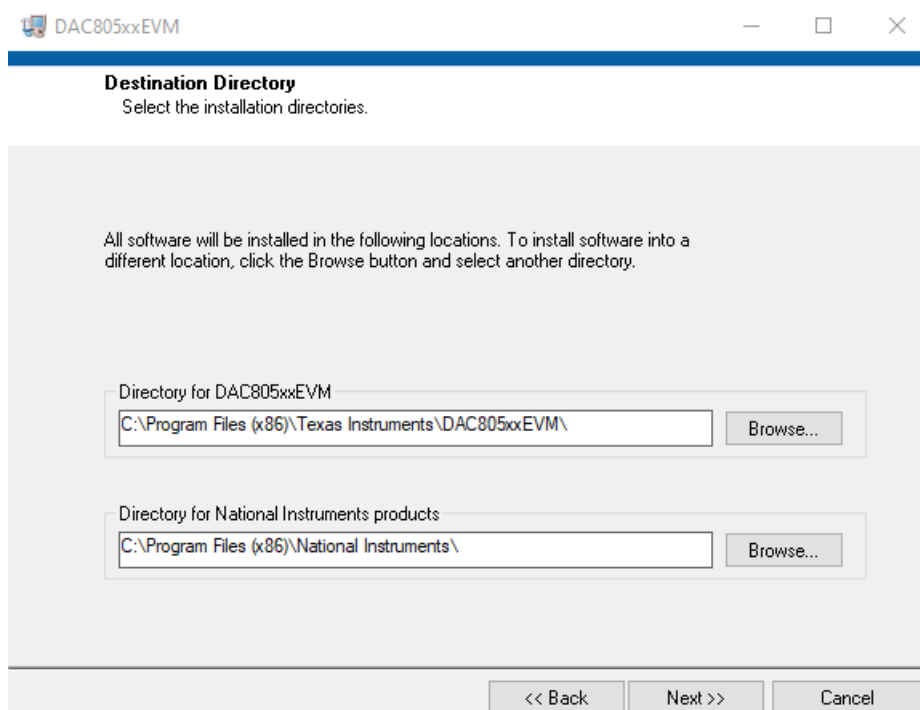


Figure 3-1. Software Installation Path

The EVM software also installs the Future Technology Devices International Limited (FTDI) USB drivers using a separate executable file. [Figure 3-2](#) shows the FTDI USB drivers installation window that is automatically launched after the DAC805xx software installation is complete.

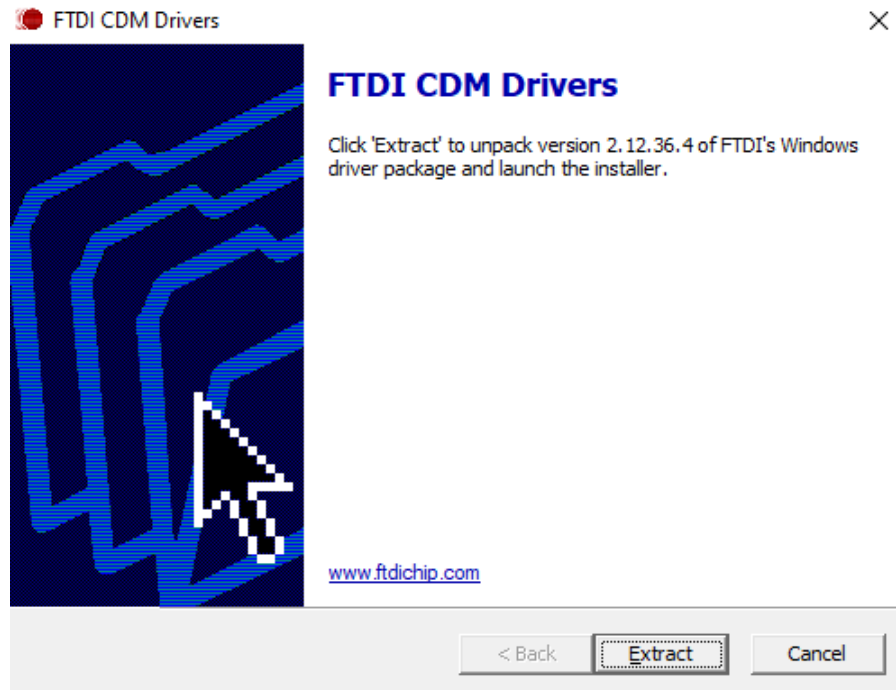


Figure 3-2. FTDI USB Drivers

3.2 Software Overview

This section discusses how to use the DAC8050xxEVM software.

3.2.1 Launching the Software

If installed in the default directory, then launch the DAC8050xxEVM software by searching for "DAC805xxEVM" in the Windows® *Start* menu.

Figure 3-3 shows the Device Setting configuration menu that is present when the GUI is launched. Select either the DAC80501 or DAC80502 device from the drop-down menu and click **CONFIG**. The software only supports one device at a time.

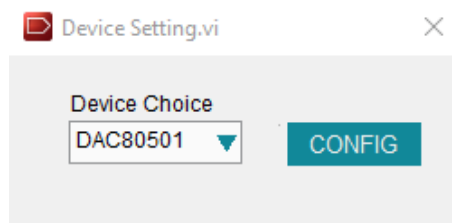


Figure 3-3. DAC805xxEVM GUI Device Settings at Launch

After a device is selected, the Interface Settings menu pops up. This menu is shown in Figure 3-4. From this menu, select the interface protocol, as well as the I²C address. Select the **CONFIG** button to save the current settings and launch the main GUI.

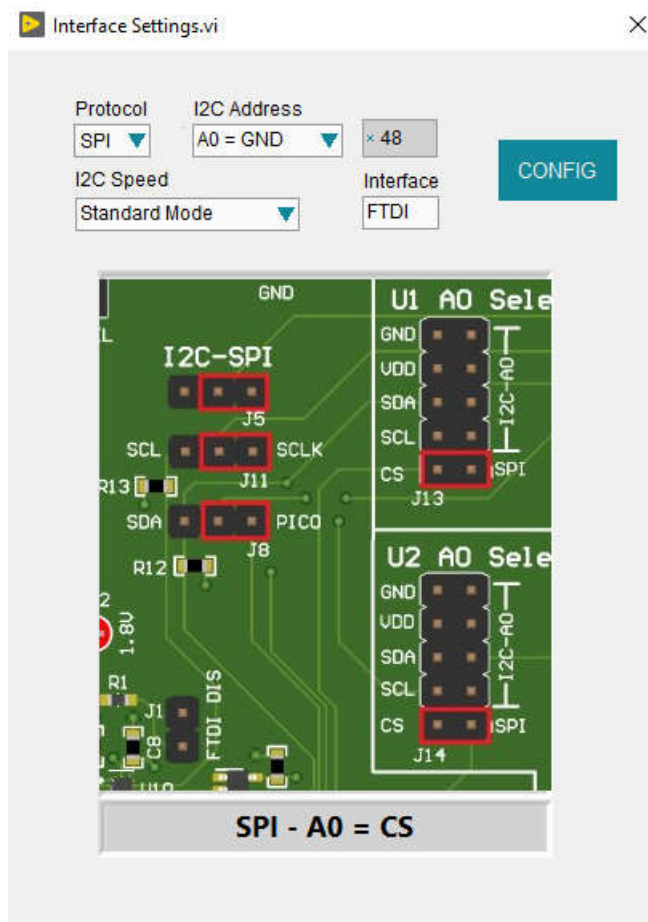


Figure 3-4. DAC8050xxEVM Interface Settings Menu

Figure 3-5 shows the GUI after launch with the DAC80501 register map loaded. Figure 3-6 shows the GUI after launch with the DAC80502 register map loaded.

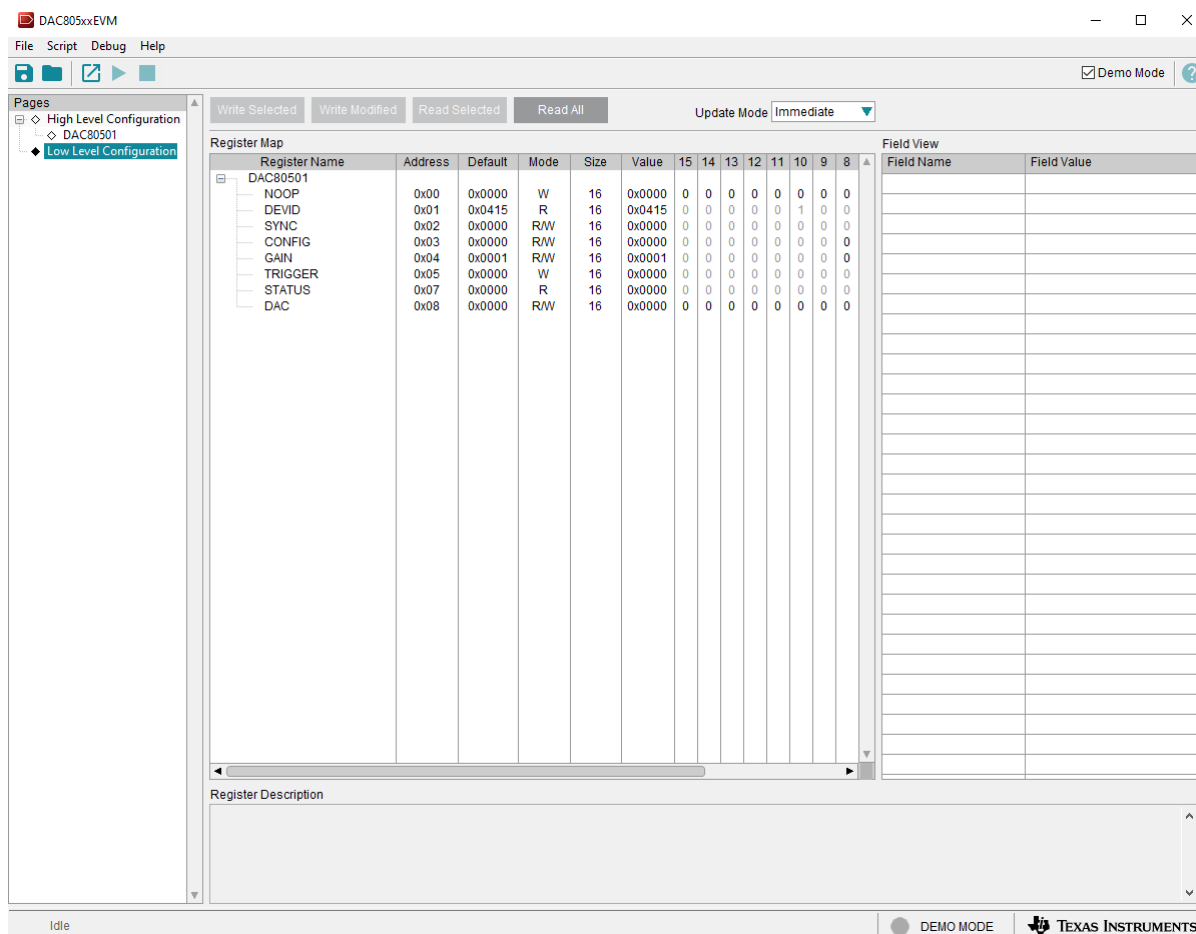


Figure 3-5. DAC805xxEVM GUI DAC80501 Selection at Launch

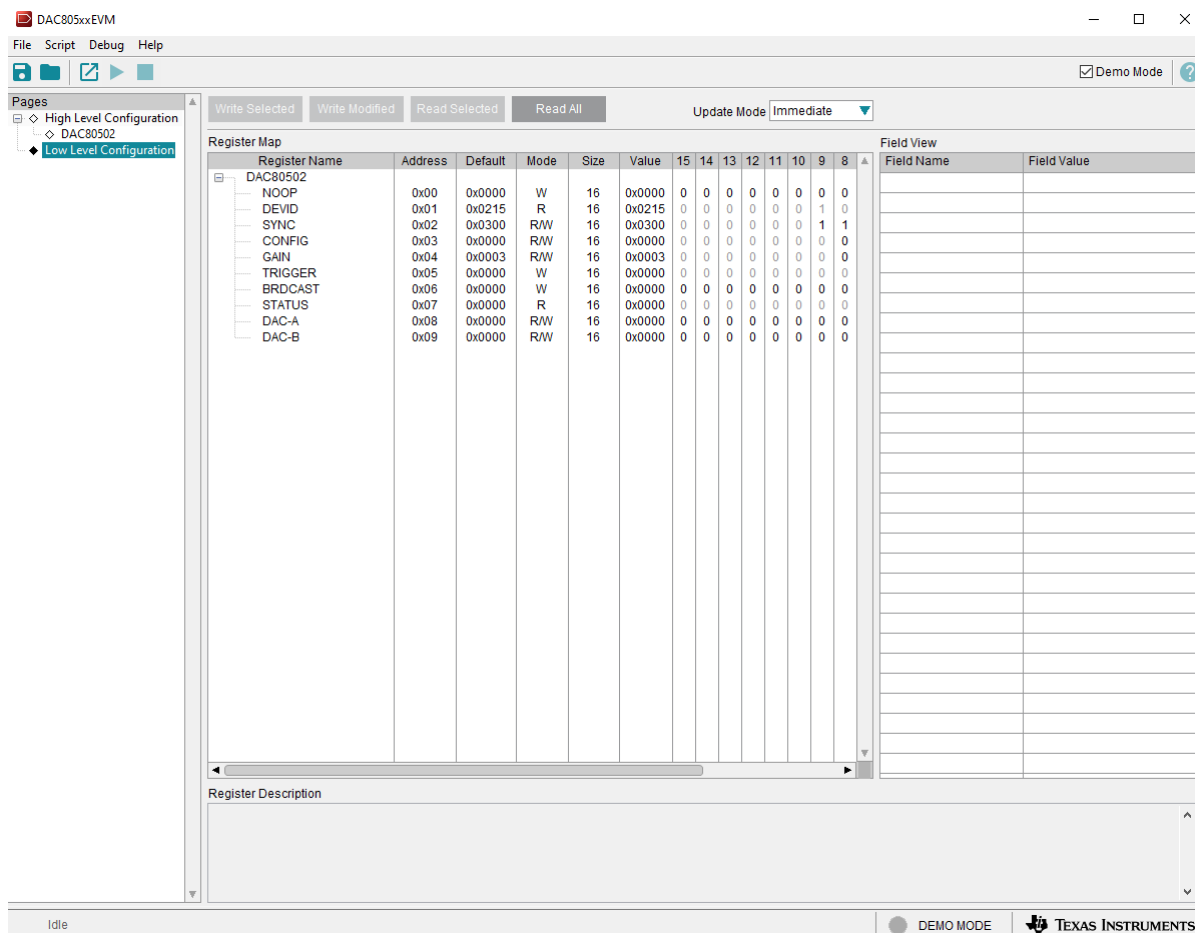


Figure 3-6. DAC805xxEVM GUI DAC80502 Selection at Launch

If the FTDI controller is not connected to the computer when the software is launched, then the GUI defaults to *demo mode*. Figure 3-7 illustrates the bottom-left corner of the GUI that shows the hardware connection status: DEMO MODE or CONNECTED. After the FTDI controller is properly connected to the computer, restart the DAC805xxEVM software to detect the device.

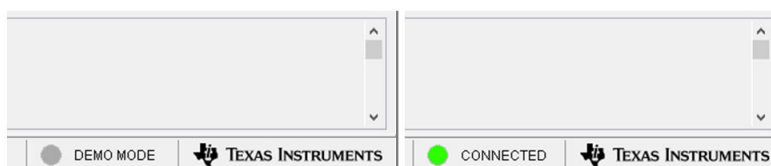


Figure 3-7. FTDI Digital Controller Connection Status

3.2.2 Software Features

The DAC805xxEVM GUI allows for I²C or SPI communication to the DAC80501 and DAC80502. Although the entire register map is available for use, some features have been abstracted into user controls in the *High-Level Configuration* page for easy operation.

3.2.2.1 Low Level Configuration Page

Figure 3-8 shows the *Low Level Configuration* page of the DAC805xxEVM GUI. This page allows direct access to all registers on the DAC80501. Figure 3-9 shows the *Low Level Configuration* page for the DAC80502.

The *Register Map* section in the center of the page lists all the registers. Directly above the *Register Map* section are four buttons that allow for read and write access to all registers.

Select a register on the Register Map list to show a description of the values in that register, as well as information on the register address, default value, size, and current value. Data are written to the registers by entering a value in the value column of the GUI.

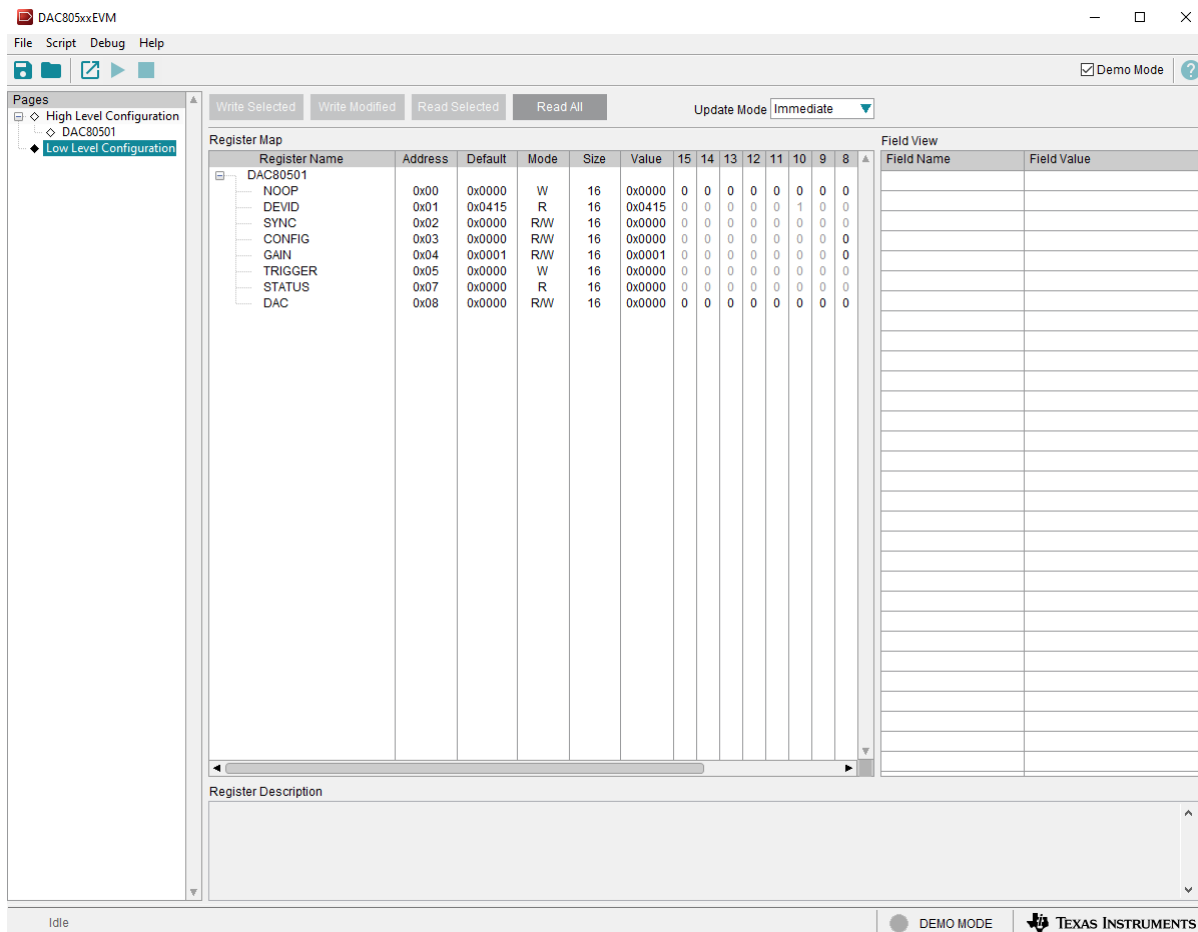


Figure 3-8. DAC80501 Low Level Configuration Page



3.2.2.2 High Level Configuration Page

The *High Level Configuration* page is used to set the configuration of the DAC805xxEVM GUI. The page is comprised of one tab: *DAC80501* if the DAC80501 device was selected, or *DAC80502* if the DAC80502 device was selected. These two tabs act as shortcuts to configure the DAC80501 and DAC80502 for basic functionality and testing.

Figure 3-10 shows the *DAC80501* tab of the *High Level Configuration* page. This tab is used to set the gain and output for the DAC. The internal reference and the reference division can also be powered on and off here.

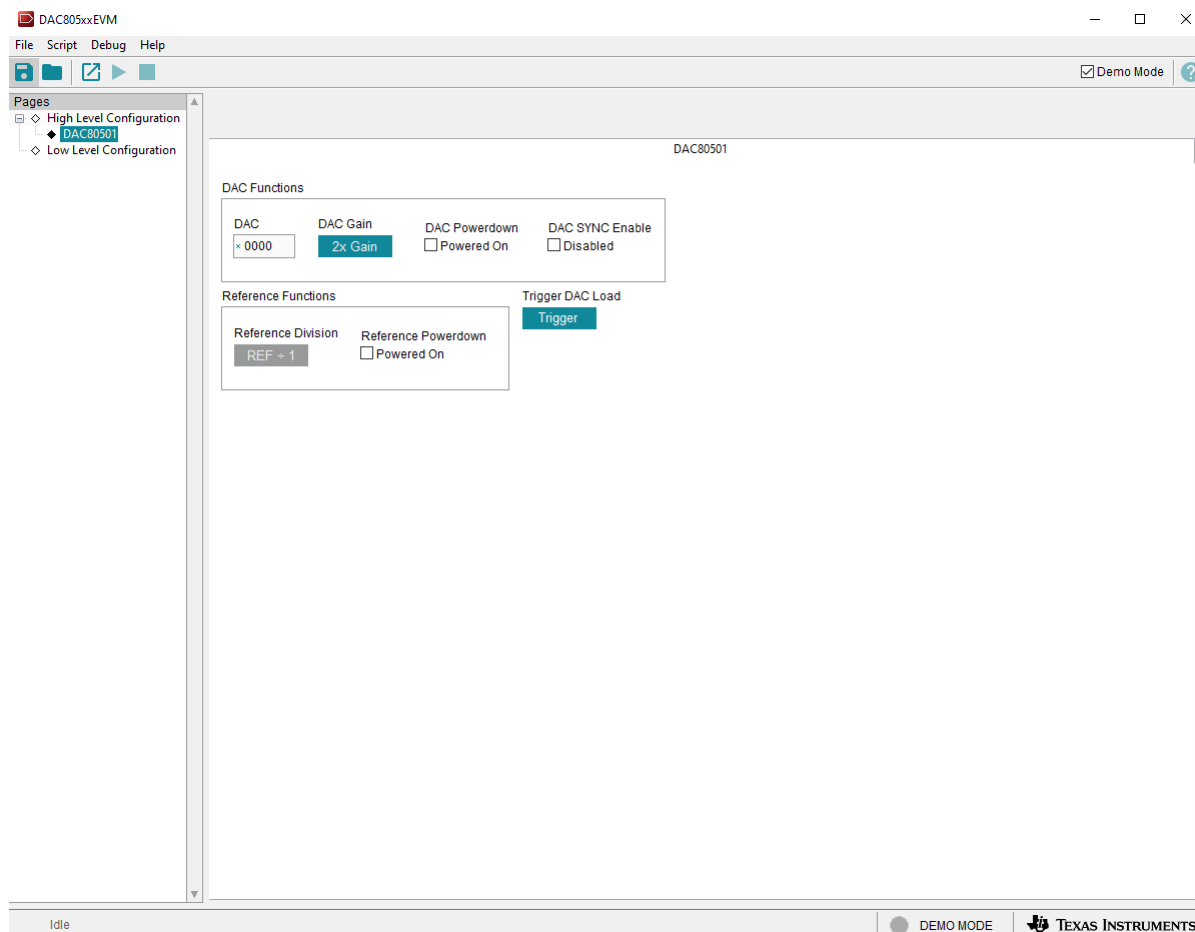


Figure 3-10. DAC80501 Tab of the High Level Configuration Page

Figure 3-11 shows the *DAC80502* tab from the *High Level Configuration* page. This tab is used to set the gain and output for the DACs. The internal reference and the reference division can also be powered on and off here.

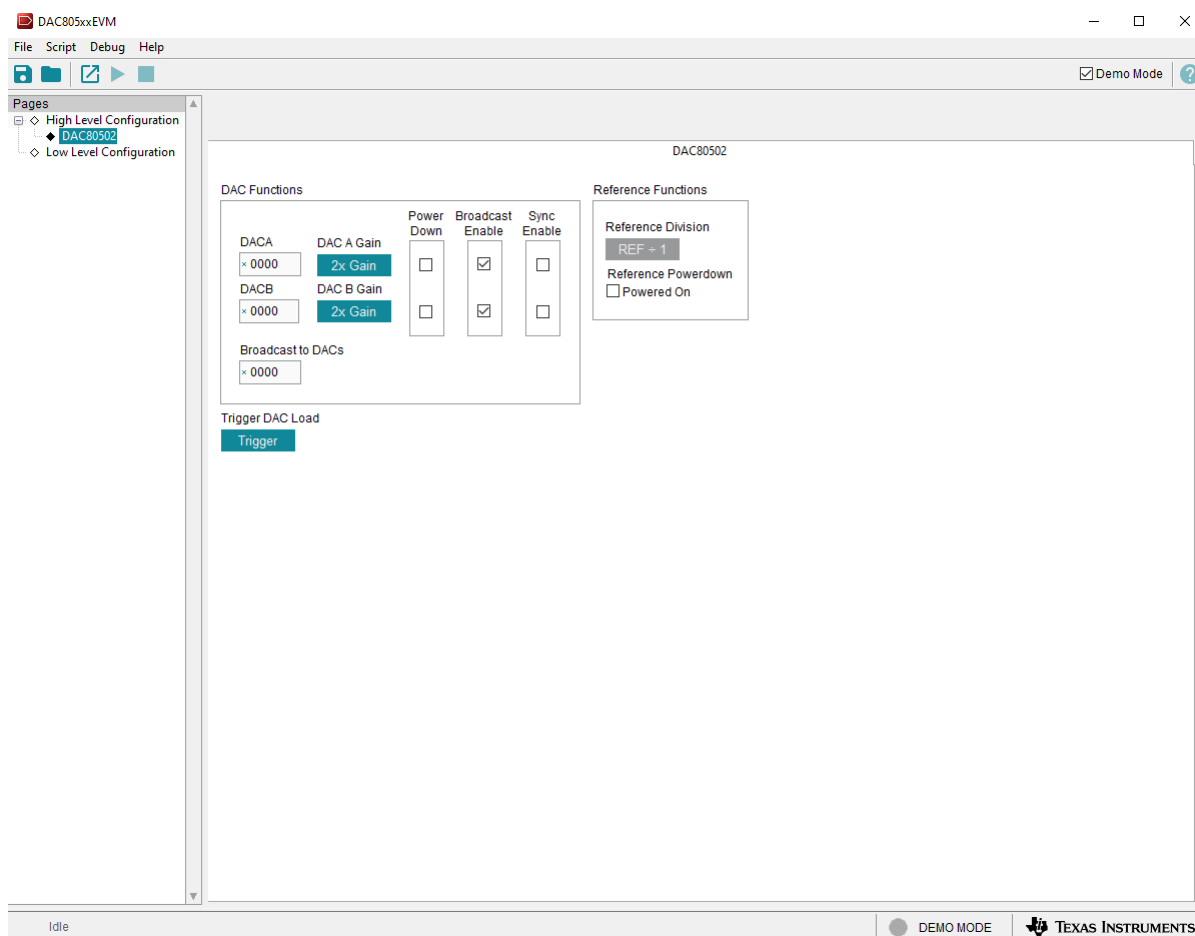


Figure 3-11. DAC80502 Tab of the High Level Configuration Page

4 Hardware Design Files

4.1 Schematics

The DAC80502-01EVM schematics are shown in [Figure 4-1](#) through [Figure 4-2](#).

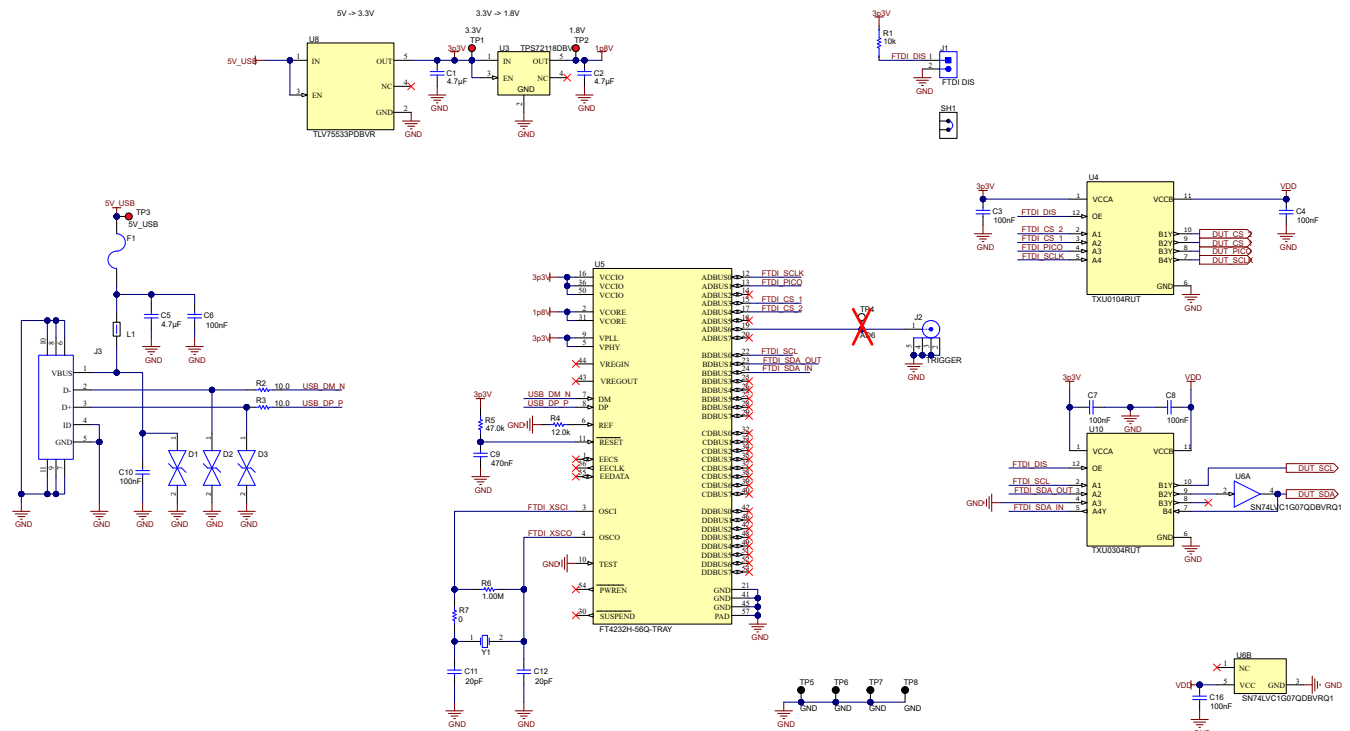


Figure 4-1. DAC80502-01EVM FTDI Schematic

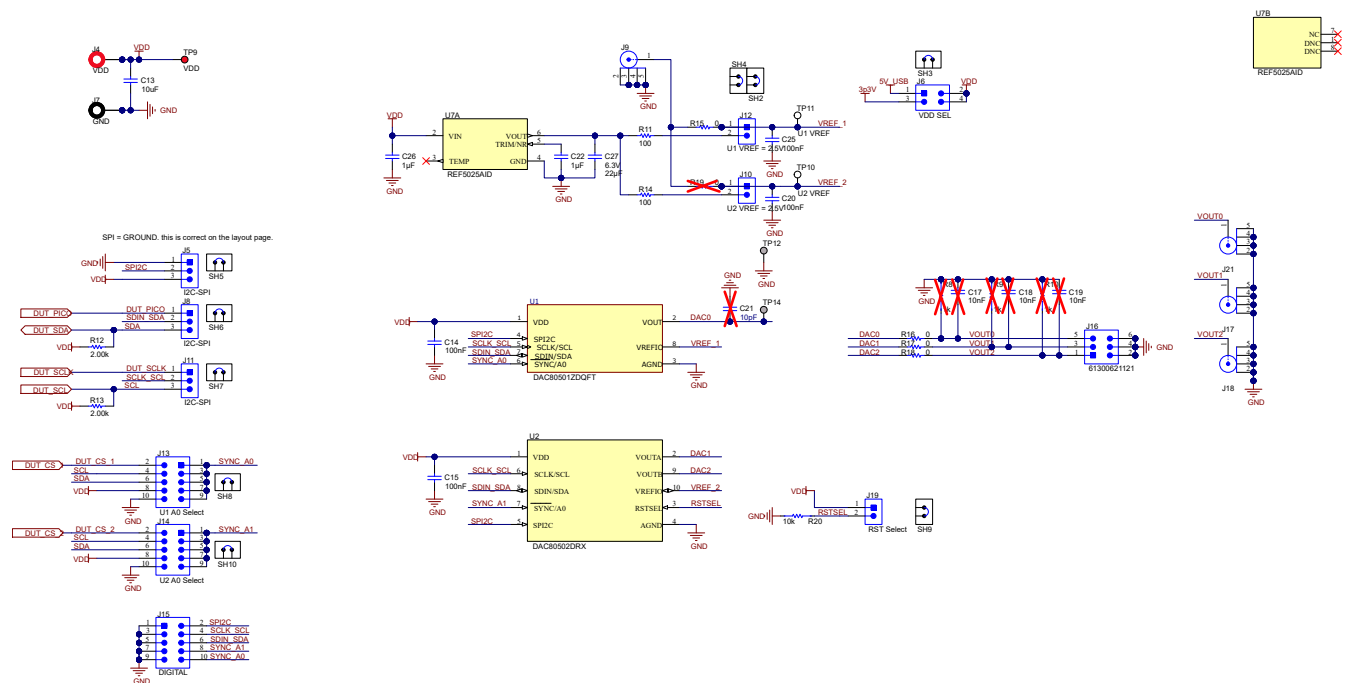


Figure 4-2. DAC80502-01EVM DUT Schematic

4.2 PCB Layout

Figure 4-3 through Figure 4-6 show the board layout for the DAC80502-01EVM.

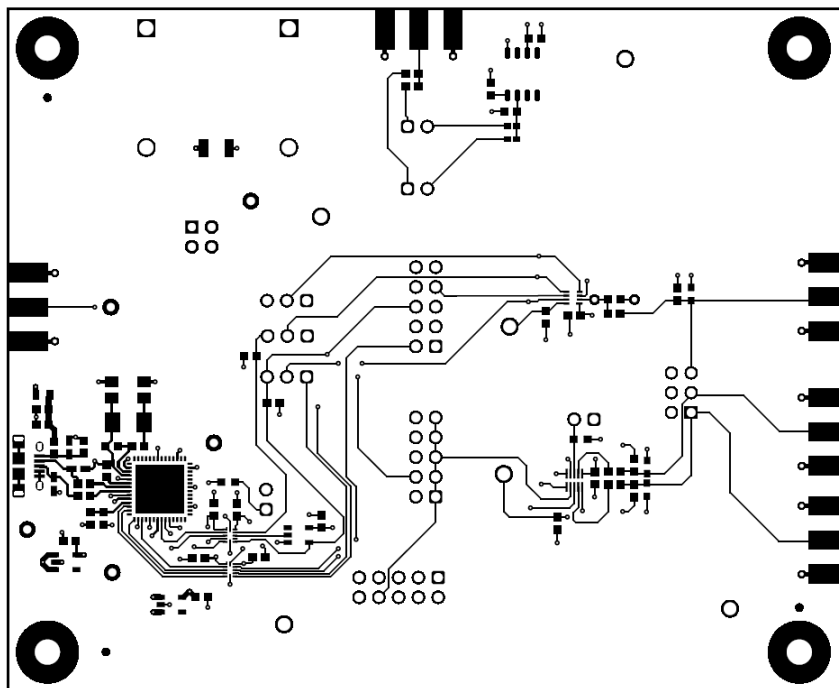


Figure 4-3. DAC80502-01EVM PCB Top Layer Layout

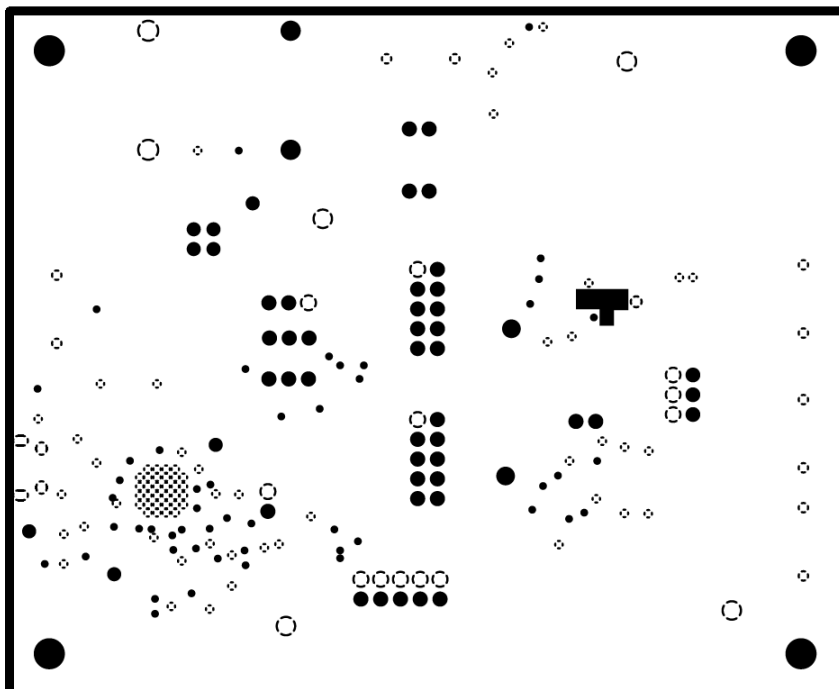


Figure 4-4. DAC80502-01EVM PCB Mid Layer 1 Layout (Ground Plane)

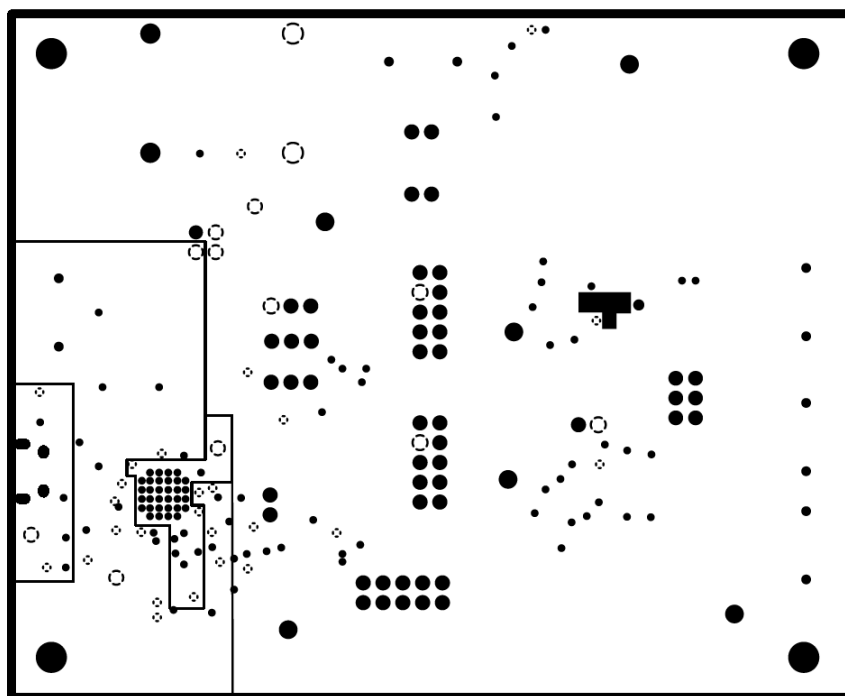


Figure 4-5. DAC80502-01EVM PCB Mid Layer 2 Layout (Power Plane)

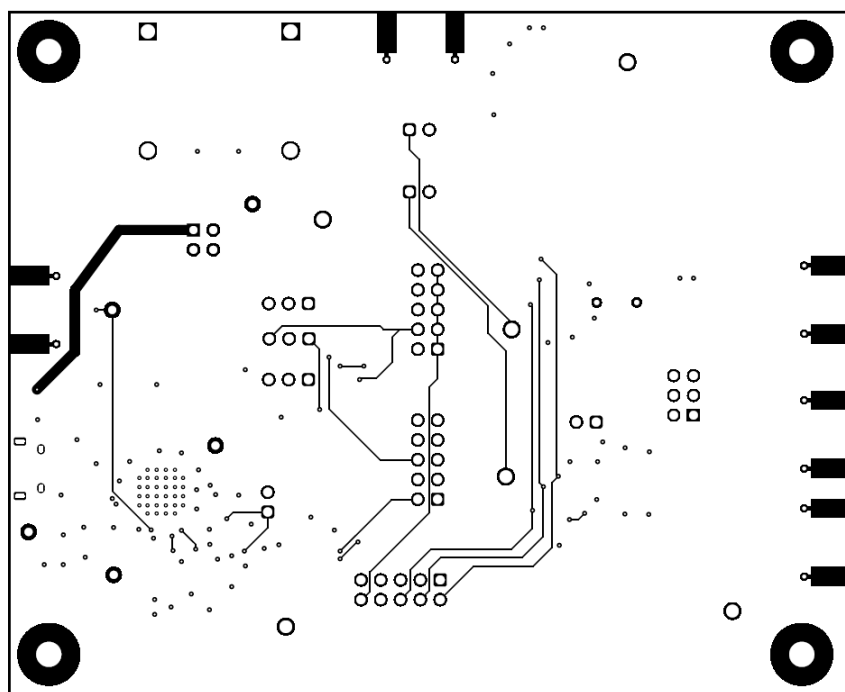


Figure 4-6. DAC80502-01EVM PCB Bottom Layer Layout

4.3 Bill of Materials

Table 4-1 lists the DAC80502-01EVM BOM.

Table 4-1. Bill of Materials for the DAC80502-01EVM

Designator	Qty	Value	Description	Package Reference	Part Number	Manufacturer
C1, C2, C5	3	4.7 μ F	CAP, CERM, 4.7 μ F, 16 V, +/- 10%, X7R, 0603	0603	GRM188Z71C475KE21D	MuRata
C3, C4, C6, C7, C8, C10, C14, C15, C16, C20, C25	11	0.1 μ F	CAP, CERM, 0.1 μ F, 50 V, +/- 10%, X7R, AEC-Q200 Grade 0, 0603	0603	06035C104K4Z4A	AVX
C9	1	0.47 μ F	CAP, CERM, 0.47 μ F, 25 V, +/- 10%, X7R, 0603	0603	GRM188R71E474KA12D	MuRata
C11, C12	2	20 pF	CAP, CERM, 20 pF, 100 V, +/- 5%, C0G/NP0, 0805	0805	08051A200JAT2A	AVX
C13	1	10 μ F	CAP, CERM, 10 μ F, 25 V, +/- 10%, X7R, 1210	1210	C1210C106K3RACTU	Kemet
C22, C26	2	1 μ F	CAP, CERM, 1 μ F, 25 V, +/- 20%, X7R, AEC-Q200 Grade 1, 0603	0603	CGA3E1X7R1E105M080AC	TDK
C27	1	22 μ F	CAP, CERM, 22 μ F, 6.3 V, +/- 20%, X6S, 0603	0603	GRM188C80J226ME15D	MuRata
D1, D2, D3	3		150 V (Typ) Clamp Ipp Tvs Diode Surface Mount 0603 (1608 Metric)	0603	PGB1010603MRHF	Littelfuse Inc
F1	1		Fuse, 0.5 A, 50 VDC, SMD	0603	SF-0603F050-2	Bourns
H1, H2, H3, H4	4		Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	Screw	NY PMS 440 0025 PH	B&F Fastener Supply
H5, H6, H7, H8	4		Standoff, Hex, 0.5"L #4-40 Nylon	Standoff	1902C	Keystone
J1, J10, J12, J19	4		Header, 2.54 mm, 2x1, Gold, TH	Header, 2.54mm, 2x1, TH	61300211121	Würth Elektronik
J3	1		Receptacle, USB 2.0, Micro-USB Type B, R/A, SMT	USB-micro B USB 2.0, 0.65mm, 5 Pos, R/A, SMT	10118194-0001LF	FCI
J4	1		Standard Banana Jack, insulated, 10 A, red	571-0500	571-0500	DEM Manufacturing
J5, J8, J11	3		Header, 2.54 mm, 3x1, Gold, TH	Header, 2.54mm, 3x1, TH	61300311121	Würth Elektronik
J6	1		Header, 100mil, 2x2, Gold, TH	2x2 Header	TSW-102-07-G-D	Samtec
J7	1		Standard Banana Jack, insulated, 10 A, black	571-0100	571-0100	DEM Manufacturing
J13, J14, J15	3		Header, 2.54 mm, 5x2, Gold, TH	Header, 2.54mm, 5x2, TH	61301021121	Würth Elektronik
J16	1		Header, 2.54mm, 3x2, Gold, TH	Header, 2.54mm, 3x2, TH	61300621121	Würth Elektronik
L1	1	600 Ω	Ferrite Bead, 600 Ω @ 100 MHz, 1 A, 0603	0603	782633601	Würth Elektronik

Table 4-1. Bill of Materials for the DAC80502-01EVM (continued)

Designator	Qty	Value	Description	Package Reference	Part Number	Manufacturer
LBL1	1		Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll	PCB Label 0.650 x 0.200 inch	THT-14-423-10	Brady
R1, R20	2	10 k Ω	10 k Ω \pm 0.1% 0.1W, 1/10W Chip Resistor 0603 (1608 Metric) Current Sense Thin Film	0603	CRT0603-BY-1002ELF	Bourns Inc.
R2, R3	2	10 Ω	RES, 10.0 Ω , 1%, 0.1 W, 0603	0603	RC0603FR-0710RL	Yageo
R4	1	12.0 k Ω	RES, 12.0 k Ω , 1%, 0.1 W, 0603	0603	RC0603FR-0712KL	Yageo
R5	1	47.0 k Ω	RES, 47.0 k Ω , 1%, 0.1 W, 0603	0603	RC0603FR-0747KL	Yageo
R6	1	1.00 M Ω	RES, 1.00 M Ω , 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	RMCF0603FG1M00	Stackpole Electronics Inc
R7, R15, R16, R17, R18	5	0 Ω	RES, 0 Ω , 5%, 0.1 W, 0603	0603	RC0603JR-070RL	Yageo
R11, R14	2	100 Ω	RES, 100 Ω , 1%, 0.063 W, 0402	0402	RC0402FR-07100RL	Yageo America
R12, R13	2	2.00 k Ω	RES, 2.00 k Ω , 0.1%, 0.1 W, 0603	0603	RG1608P-202-B-T5	Susumu Co Ltd
SH1, SH2, SH3, SH4, SH5, SH6, SH7, SH8, SH9, SH10	10		Shunt, 100mil, Gold plated, Black	Shunt 2 pos. 100 mil	881545-2	TE Connectivity
TP1, TP2, TP3, TP9	4		Test Point, Miniature, Red, TH	Red Miniature Testpoint	5000	Keystone, Keystone Electronics
TP5, TP6, TP7, TP8	4		Test Point, Multipurpose, Black, TH	Black Multipurpose Testpoint	5011	Keystone Electronics
TP10, TP11	2		Test Point, Compact, White, TH	White Compact Testpoint	5007	Keystone Electronics
U1	1		True 16-bit, 1-ch, SPI/I ² C, voltage-output DAC in WSON package with precision internal reference 8-WSON -40 to 125	WSON8	DAC80501ZDQFT	Texas Instruments
U2	1		DAC80502DRX, DRX0010A (WSON-10)	DRX0010A	DAC80502DRX	Texas Instruments
U3	1		Single Output Low Input Voltage Requirement LDO, 150 mA, Fixed 1.8 V Output, 1.8 to 5.5 V Input, with Low IQ, 5-pin SOT-23 (DBV), -40 to 125 degC, Green (RoHS & no Sb/Br)	DBV0005A	TPS72118DBVR	Texas Instruments

Table 4-1. Bill of Materials for the DAC80502-01EVM (continued)

Designator	Qty	Value	Description	Package Reference	Part Number	Manufacturer
U4	1		4-Bit Fixed Direction Voltage-Level Translator with Schmitt-Trigger Inputs, and Tri-State Outputs	UQFN12	TXU0104RUT	Texas Instruments
U5	1		Future Technology Devices International Ltd FT4232H Quad High Speed USB to Multipurpose UART/MPSSE IC, VQFN-56	VQFN-56	FT4232H-56Q-TRAY	FTDI
U6	1		Automotive Catalog Single Buffer/Driver With Open-Drain Output, DBV0005A (SOT-23-5)	DBV0005A	SN74LVC1G07QDBVRQ1	Texas Instruments
U7	1		Low Noise, Very Low Drift, Precision Voltage Reference, -40 to 125 degC, 8-pin SOIC (D), Green (RoHS & no Sb/Br)	D0008A	REF5025AID	Texas Instruments
U8	1		500-mA, Low IQ, Small Size, Low Dropout Regulator, DBV0005A (SOT-23-5)	DBV0005A	TLV75533PDBVR	Texas Instruments
U10	1		Automotive 4-Bit Fixed Direction Voltage-Level Translator with Schmitt-Trigger Inputs, and Tri-State Outputs	UQFN12	TXU0304RUT	Texas Instruments
Y1	1		Crystal, 12 MHz, 18 pF, SMD	ABM3	ABM3-12.000MHZ-B2-T	Abracon Corporation
C17, C18, C19	0			0603		
C21	0			0603		
J2, J9, J17, J18, J21	0		Connector, End launch SMA, 50 Ω , SMT	End Launch SMA	142-0701-801	Cinch Connectivity
R8, R9, R10	0			0603		
R19	0	0 Ω		0603		

5 Additional Information

Trademarks

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6 Related Documentation

The documents in [Table 6-1](#) provide information regarding Texas Instruments integrated circuits used in the assembly of the DAC80502-01EVM. This user's guide is available from the TI web site under literature number SLAU919. Any letter appended to the literature number corresponds to the document revision that is current at the time of the writing of this document. Newer revisions are available from the TI web site at www.ti.com, or call the Texas Instruments Literature Response Center at (800) 477-8924 or the Product Information Center at (972) 644-5580. When ordering, identify the document by both title and literature number.

Table 6-1. Related Device Documentation

Document	Literature Number
DACx0501 product data sheet	SBAS794
DACx0502 product data sheet	SBAS793

STANDARD TERMS FOR EVALUATION MODULES

1. *Delivery:* TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.
 - 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms that accompany such Software
 - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
2. *Limited Warranty and Related Remedies/Disclaimers:*
 - 2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
 - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after delivery, or of any hidden defects with ten (10) business days after the defect has been detected.
 - 2.3 TI's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

WARNING

Evaluation Kits are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems.

User shall operate the Evaluation Kit within TI's recommended guidelines and any applicable legal or environmental requirements as well as reasonable and customary safeguards. Failure to set up and/or operate the Evaluation Kit within TI's recommended guidelines may result in personal injury or death or property damage. Proper set up entails following TI's instructions for electrical ratings of interface circuits such as input, output and electrical loads.

NOTE:

EXPOSURE TO ELECTROSTATIC DISCHARGE (ESD) MAY CAUSE DEGRADATION OR FAILURE OF THE EVALUATION KIT; TI RECOMMENDS STORAGE OF THE EVALUATION KIT IN A PROTECTIVE ESD BAG.

3 Regulatory Notices:

3.1 United States

3.1.1 Notice applicable to EVMs not FCC-Approved:

FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- *Reorient or relocate the receiving antenna.*
- *Increase the separation between the equipment and receiver.*
- *Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.*
- *Consult the dealer or an experienced radio/TV technician for help.*

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

3.3 Japan

3.3.1 *Notice for EVMs delivered in Japan:* Please see http://www.tij.co.jp/sds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。

<https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-delivered-in-japan.html>

3.3.2 *Notice for Users of EVMs Considered "Radio Frequency Products" in Japan:* EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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3.3.3 *Notice for EVMs for Power Line Communication:* Please see http://www.tij.co.jp/sds/ti_ja/general/eStore/notice_02.page

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3.4 European Union

3.4.1 *For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):*

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

4 *EVM Use Restrictions and Warnings:*

4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.

4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.

4.3 *Safety-Related Warnings and Restrictions:*

4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.

4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.

4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.

5. *Accuracy of Information:* To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.

6. *Disclaimers:*

6.1 EXCEPT AS SET FORTH ABOVE, EVMS AND ANY MATERIALS PROVIDED WITH THE EVM (INCLUDING, BUT NOT LIMITED TO, REFERENCE DESIGNS AND THE DESIGN OF THE EVM ITSELF) ARE PROVIDED "AS IS" AND "WITH ALL FAULTS." TI DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, REGARDING SUCH ITEMS, INCLUDING BUT NOT LIMITED TO ANY EPIDEMIC FAILURE WARRANTY OR IMPLIED WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF ANY THIRD PARTY PATENTS, COPYRIGHTS, TRADE SECRETS OR OTHER INTELLECTUAL PROPERTY RIGHTS.

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8.2 *Specific Limitations.* IN NO EVENT SHALL TI'S AGGREGATE LIABILITY FROM ANY USE OF AN EVM PROVIDED HEREUNDER, INCLUDING FROM ANY WARRANTY, INDEMNITY OR OTHER OBLIGATION ARISING OUT OF OR IN CONNECTION WITH THESE TERMS, EXCEED THE TOTAL AMOUNT PAID TO TI BY USER FOR THE PARTICULAR EVM(S) AT ISSUE DURING THE PRIOR TWELVE (12) MONTHS WITH RESPECT TO WHICH LOSSES OR DAMAGES ARE CLAIMED. THE EXISTENCE OF MORE THAN ONE CLAIM SHALL NOT ENLARGE OR EXTEND THIS LIMIT.

9. *Return Policy.* Except as otherwise provided, TI does not offer any refunds, returns, or exchanges. Furthermore, no return of EVM(s) will be accepted if the package has been opened and no return of the EVM(s) will be accepted if they are damaged or otherwise not in a resalable condition. If User feels it has been incorrectly charged for the EVM(s) it ordered or that delivery violates the applicable order, User should contact TI. All refunds will be made in full within thirty (30) working days from the return of the components(s), excluding any postage or packaging costs.
10. *Governing Law:* These terms and conditions shall be governed by and interpreted in accordance with the laws of the State of Texas, without reference to conflict-of-laws principles. User agrees that non-exclusive jurisdiction for any dispute arising out of or relating to these terms and conditions lies within courts located in the State of Texas and consents to venue in Dallas County, Texas. Notwithstanding the foregoing, any judgment may be enforced in any United States or foreign court, and TI may seek injunctive relief in any United States or foreign court.

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